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# **FDMA1027P**

# July 2014

# **Dual P-Channel PowerTrench® MOSFET**

# **General Description**

This device is designed specifically as a single package solution for the battery charge switch in cellular handset and other ultra-portable applications. It features two independent P-Channel MOSFETs with low on-state resistance for minimum conduction losses. When connected in the typical common source configuration, bi-directional current flow is possible.

The MicroFET 2x2 package offers exceptional thermal performance for it's physical size and is well suited to linear mode applications.

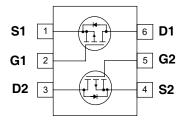
#### **Features**

- -3.0 A, -20V.  $R_{DS(ON)} = 120 \text{ m}\Omega$  @  $V_{GS} = -4.5 \text{ V}$ 
  - $R_{DS(ON)} = 160 \text{ m}\Omega$  @  $V_{GS} = -2.5 \text{ V}$
  - $R_{DS(ON)}$  = 240 m $\Omega$  @  $V_{GS}$  = -1.8 V
- Low Profile 0.8 mm maximun in the new package MicroFET 2x2 mm
- RoHS Compliant
- Free from halogenated compounds and antimony oxides









# Absolute Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	MOSFET Drain-Source Voltage		-20	V
V <sub>GSS</sub>	MOSFET Gate-Source Voltage		±8	V
ı	Drain Current -Continuous	(Note 1a)	-3.0	Α
l <sub>D</sub>	-Pulsed		-6	7 1
	Power dissipation	(Note 1a)	1.4	
P <sub>D</sub>		(Note 1b)	0.7	] ,,,
' D		(Note 1c)	1.8	W
		(Note 1d)	0.8	1
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

## **Thermal Characteristics**

$R_{\theta JA}$	Thermal Resistance for Single Operation, Junction-to-Ambient	(Note 1a)	86	
$R_{\theta JA}$	Thermal Resistance for Single Operation, Junction-to-Ambient	(Note 1b)	173	°C/W
$R_{\theta JA}$	Thermal Resistance for Dual Operation, Junction-to-Ambient	(Note 1c)	69	C/VV
$R_{\theta,JA}$	Thermal Resistance for Dual Operation, Junction-to-Ambient	(Note 1d)	151	

# **Package Marking and Ordering Information**

Device Marking	Device	Reel Size	Tape Width	Quantity
027	FDMA1027P	7"	8mm	3000 units

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# **Electrical Characteristics** $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = -250\mu A$	-20	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = -250μA, Referenced to 25°C	-	-12	-	mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16V, V_{GS} = 0V$	-	-	-1	μΑ
I <sub>GSS</sub>	Gate-Body Leakage,	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$	-	-	±100	nA

# On Characteristics (Note 2)

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.4	-0.7	-1.3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I <sub>D</sub> = -250μA, Referenced to 25°C	-	2	-	mV/°C
		$V_{GS} = -4.5V, I_D = -3.0A$	-	90	120	
		$V_{GS} = -2.5V, I_D = -2.5A$	-	120	160	
R <sub>DS(ON)</sub>		$V_{GS} = -1.8V, I_D = -1.0A$	-	172	240	mΩ
		$V_{GS} = -4.5V, I_D = -3.0A$ $T_J = 125^{\circ}C$	-	118	160	
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = -4.5V, V_{DS} = -5V$	-20	-	-	Α
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5V, I_{D} = -3.0A$	-	7	-	S

# **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	101/1/	-	435	-	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz	-	80	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1.0WH12	-	45	-	pF

# **Switching Characteristics** (Note 2)

t <sub>d(on)</sub>	Turn-On Delay Time		-	9	18	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>DD</sub> = -10V, I <sub>D</sub> = -1A	-	11	19	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$	-	15	27	ns
t <sub>f</sub>	Turn-Off Fall Time		-	6	12	ns
$Q_g$	Total Gate Charge	101/ 1 0 0 1	-	4	6	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{DS} = -10V, I_{D} = -3.0A,$ $V_{GS} = -4.5V$	-	0.8	-	nC
Q <sub>qd</sub>	Gate-Drain Charge	VGS = -7.5V	-	0.9	-	nC

# **Drain-Source Diode Characteristics and Maximum Ratings**

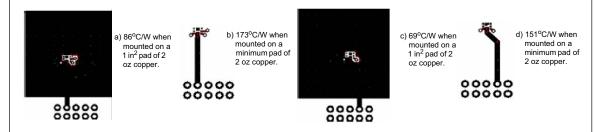
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current		-	-	-1.1	Α
$V_{SD}$	Drain-Source Diode Forward Voltage V <sub>GS</sub> = 0V, I <sub>S</sub> = -1.1 A (Note 2)		-	-0.8	-1.2	V
t <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>F</sub> = -3.0A, dI <sub>F</sub> /dt=100A/μs	-	17	-	ns
Q <sub>rr</sub>	Diode Reverse Recovery Charge	- 1 - 3.0A, αιε/αι= 100A/μs	-	6	-	nC

# Electrical Characteristics T<sub>A</sub> = 25°C unless otherwise noted

- 1:  $R_{0JA}$  is determined with the device mounted on a 1 in<sup>2</sup> oz. copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{0JC}$  is guaranteed by design while  $R_{0JA}$  is determined by the user's board design.

  (a)  $R_{0JA} = 86^{\circ}\text{C/W}$  when mounted on a 1in<sup>2</sup> pad of 2 oz copper, 1.5" x 1.5" x 0.062" thick PCB. For single operation.

  - (b)  $R_{\rm 0JA}$  = 173°C/W when mounted on a minimum pad of 2 oz copper. For single operation.
  - (c) R<sub>0,JA</sub> = 69°C/W when mounted on a 1in<sup>2</sup> pad of 2 oz copper, 1.5" x 1.5" x 0.062" thick PCB, For dual operation, configured in parallel.
  - (d)  $R_{\theta JA}$  = 151°C/W when mounted on a minimum pad of 2 oz copper. For dual operation, configured in parallel.



2: Pulse Test : Pulse Width < 300us, Duty Cycle < 2.0%

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# **Typical Characteristics**

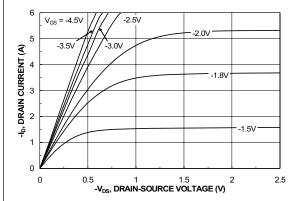
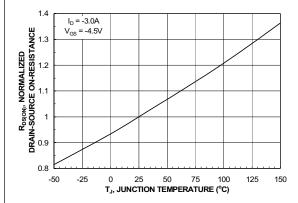


Figure 1. On-Region Characteristics

Figure 2. On-Resistance Variation with Drain Current and Gate Voltage



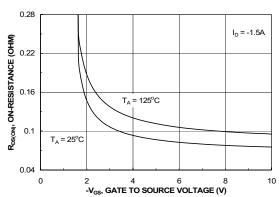
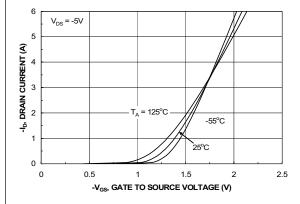


Figure 3. On-Resistance Variation with Temperature

Figure 4. On-Resistance Variation with Gate-to-Source Voltage



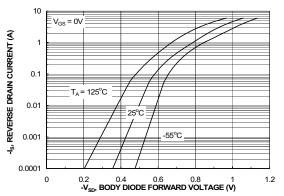


Figure 5. Transfer Characteristics

Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

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**Typical Characteristics** 

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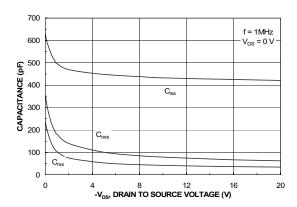
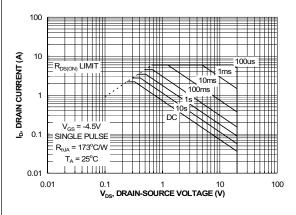


Figure 7. Gate Charge Characteristics

Q<sub>g</sub>, GATE CHARGE (nC)

Figure 8. Capacitance Characteristics



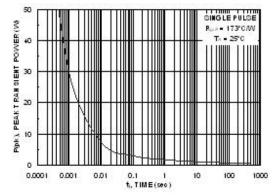


Figure 9. Maximum Safe Operation Area

Figure 10. Single Pulse Maximum Power Dissipation

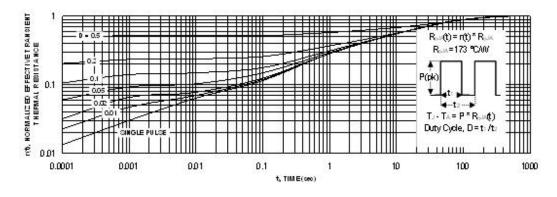
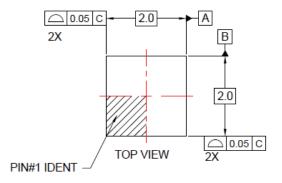
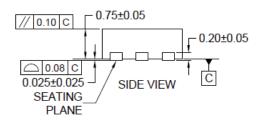


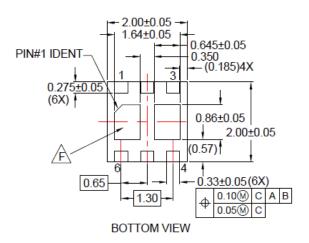
Figure 11. Transient Thermal Response Curve

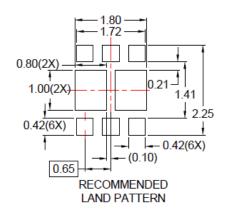
Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.

# **Dimensional Outline and Pad Layout**









#### NOTES:

- A. CONFORM TO JADEC REGISTRATIONS MO-229, VARIATION VCCC, EXCEPT WHERE NOTED.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-UMLP16Erev4
- F. NON-JEDEC DUAL DAP



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